

PATENT ASSIGNMENT

Electronic Version v1.1
Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Il Kwon Shim</td><td>05/15/2009</td></tr><tr><td>Seng Guan Chow</td><td>05/15/2009</td></tr><tr><td>Heap Hoe Kuan</td><td>05/15/2009</td></tr><tr><td>Seung Uk Yoon</td><td>05/15/2009</td></tr><tr><td>Jong-Woo Ha</td><td>05/22/2009</td></tr></tbody></table>		Name	Execution Date	Il Kwon Shim	05/15/2009	Seng Guan Chow	05/15/2009	Heap Hoe Kuan	05/15/2009	Seung Uk Yoon	05/15/2009	Jong-Woo Ha	05/22/2009
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RECEIVING PARTY DATA													
<table border="1"><tr><td>Name:</td><td>STATS ChipPAC Ltd.</td></tr><tr><td>Street Address:</td><td>10 Ang Mo Kio Street 65</td></tr><tr><td>Internal Address:</td><td>#05-17/20 Techpoint</td></tr><tr><td>City:</td><td>Singapore</td></tr><tr><td>State/Country:</td><td>SINGAPORE</td></tr><tr><td>Postal Code:</td><td>569059</td></tr></table>		Name:	STATS ChipPAC Ltd.	Street Address:	10 Ang Mo Kio Street 65	Internal Address:	#05-17/20 Techpoint	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	569059
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PROPERTY NUMBERS Total: 2													
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12473233</td></tr><tr><td>Application Number:</td><td>61074612</td></tr></tbody></table>		Property Type	Number	Application Number:	12473233	Application Number:	61074612						
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Application Number:	12473233												
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CORRESPONDENCE DATA													
Fax Number: (408)738-0881 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone: 408-738-0592													
Email: efilng@ishimarulaw.com													
Correspondent Name: LAW OFFICES OF MIKIO ISHIMARU													
Address Line 1: 333 W. EL CAMINO REAL													
Address Line 2: SUITE 330													
Address Line 4: SUNNYVALE, CALIFORNIA 94087													

500885475

PATENT
REEL: 022822 FRAME: 0523

CH \$80.00 12473233

ATTORNEY DOCKET NUMBER:	27-553P & 27-553
NAME OF SUBMITTER:	Mikio Ishimaru
Total Attachments: 4 source=27-553_Assignment#page1.tif source=27-553_Assignment#page2.tif source=27-553_Assignment#page3.tif source=27-553_Assignment#page4.tif	

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGING SYSTEM WITH EMBEDDED CIRCUITRY AND POST, AND METHOD OF MANUFACTURE THEREOF

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):


1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

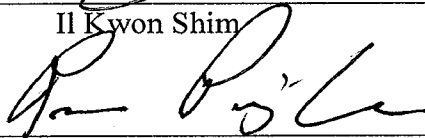
5. Said Assignor(s) hereby authorize and request the attorney(s) of record in this application to insert the serial number and filing date of this Non Provisional application and that of the Provisional application from which it claims priority in the spaces that follow:

Serial Number: 61/074,612 Filing Date: June 20, 2008.

Serial Number: 12/473,233 Filing Date: May 27, 2009.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



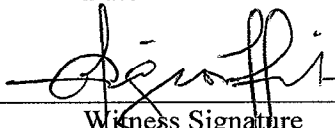
 Il Kyon Shim


 Witness Signature
 REZA PAGAILA

 Print Witness Name
 15-May-2009

 Date

15-May-2009

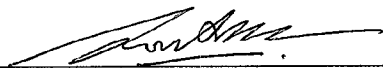
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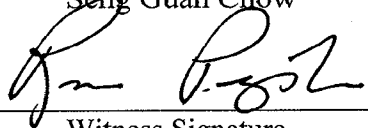
 Witness Signature
 DIOSCORO MERILO

 Print Witness Name
 15 MAY 2009

 Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



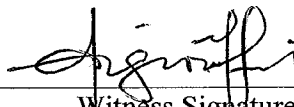
 Seng Guan Chow


 Witness Signature
 REZA PAGAILA

 Print Witness Name
 15-May-2009

 Date

15 May 2009


 Date


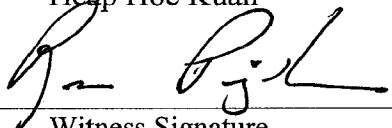
 Witness Signature
 DIOSCORO MERILO

 Print Witness Name
 15 MAY 2009

 Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.




 Heap Hoe Kuan


 Witness Signature
 REZA PABAILA.

 Print Witness Name
 15-MAY-2009.

 Date

15 May 2009

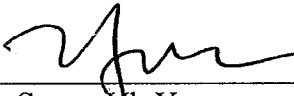
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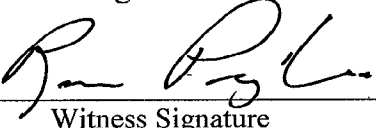
 Witness Signature
 DI SCORERO MERILO

 Print Witness Name
 15 MAY 2009

 Date

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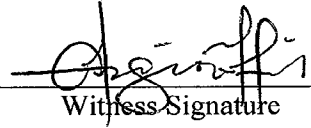
 Seung Uk Yoon


 Witness Signature
 REZA PABAILA.

 Print Witness Name
 15-MAY-2009.

 Date

15 May 2009

 Date


 Witness Signature
 DI SCORERO MERILO

 Print Witness Name
 15 MAY 2009

 Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

~~_____~~
 Jong-Woo Ha

 Date

 Witness Signature

 Print Witness Name

 Date

~~_____~~

 Date

 Witness Signature

 Print Witness Name

 Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

_____ Heap Hoe Kuan	_____ Date
_____ Witness Signature	_____ Witness Signature
_____ Print Witness Name	_____ Print Witness Name
_____ Date	_____ Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

_____ Seung Uk Yoon	_____ Date
_____ Witness Signature	_____ Witness Signature
_____ Print Witness Name	_____ Print Witness Name
_____ Date	_____ Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

_____ Jong-Woo Ha	_____ 2009-05-22 Date
_____ Witness Signature	_____ Witness Signature
_____ REZA PABAILA . Print Witness Name	_____ DIO SCOPPO MERINO Print Witness Name
_____ 22-05-2009. Date	_____ 22 MAY 2009 Date